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**Kuriyama et al.**

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(54) **ELECTROLYTIC PLATING ANODE**

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(73) Assignee: **Ebara Corporation**, Tokyo (JP)

(\*\*) Term: **14 Years**

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(51) **LOC (8) Cl.** ..... **13-03**

(52) **U.S. Cl.** ..... **D13/182**

(58) **Field of Classification Search** ..... D13/182;  
D26/1, 24, 72, 74, 89; 204/280, 286.1, 297.01,  
204/297.1; 205/98, 528; 206/454, 711; 361/523,  
361/528, 529; 257/678

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for an electrolytic plating anode, as shown and described.

**DESCRIPTION**

The claimed electrolytic plating anode is used to perform an electrolytic plating process in a plating bath when a voltage is applied via an anode shaft connected to the electrolytic plating anode.

FIG. 1 is a front elevation view of an electrolytic plating anode;

FIG. 2 is a rear view of the electrolytic plating anode shown in FIG. 1;

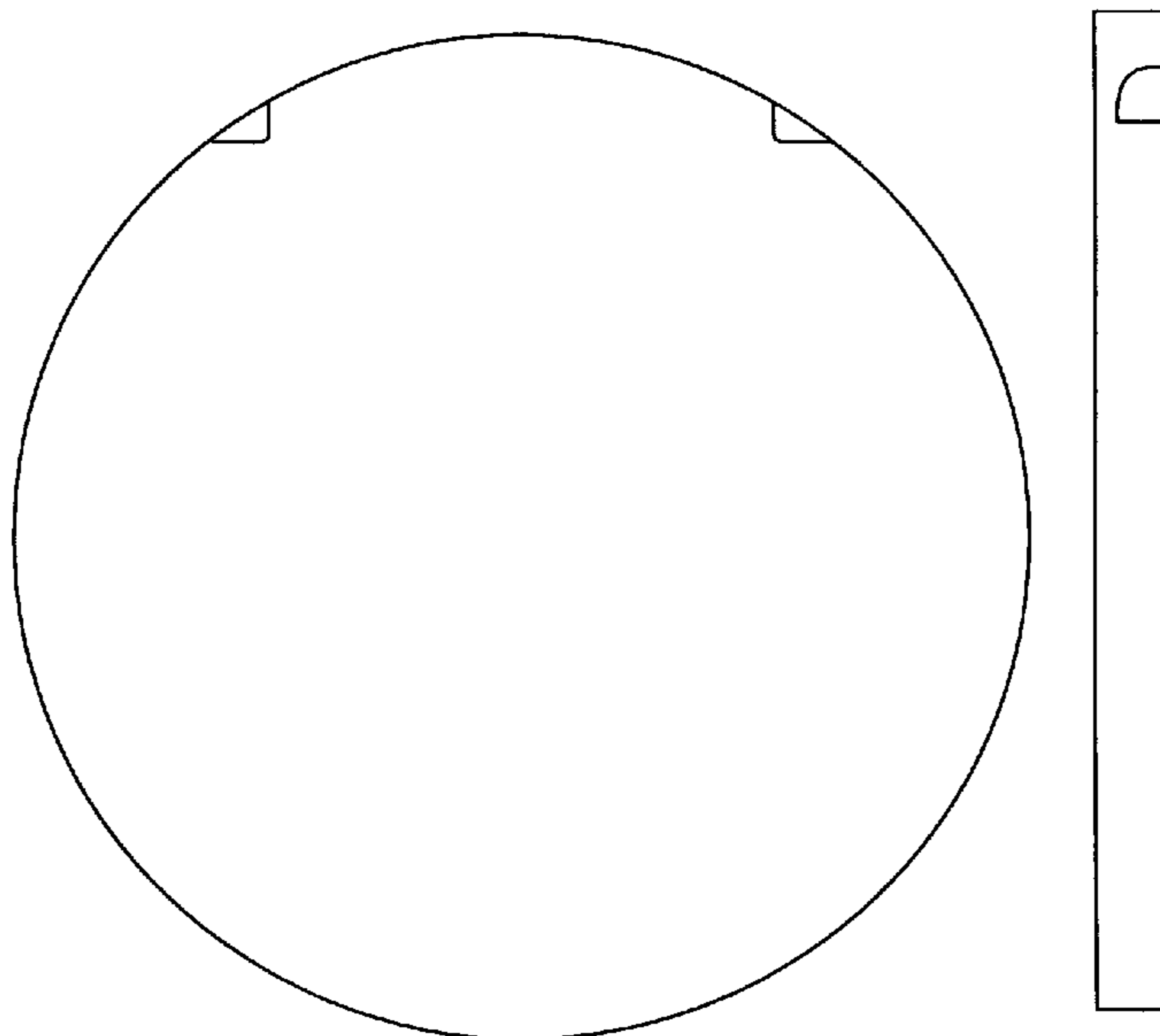
FIG. 3 is a top plan view of the electrolytic plating anode shown in FIG. 1, wherein the broken lines form no part of the claimed design;

FIG. 4 is a bottom plan view of the electrolytic plating anode shown in FIG. 1;

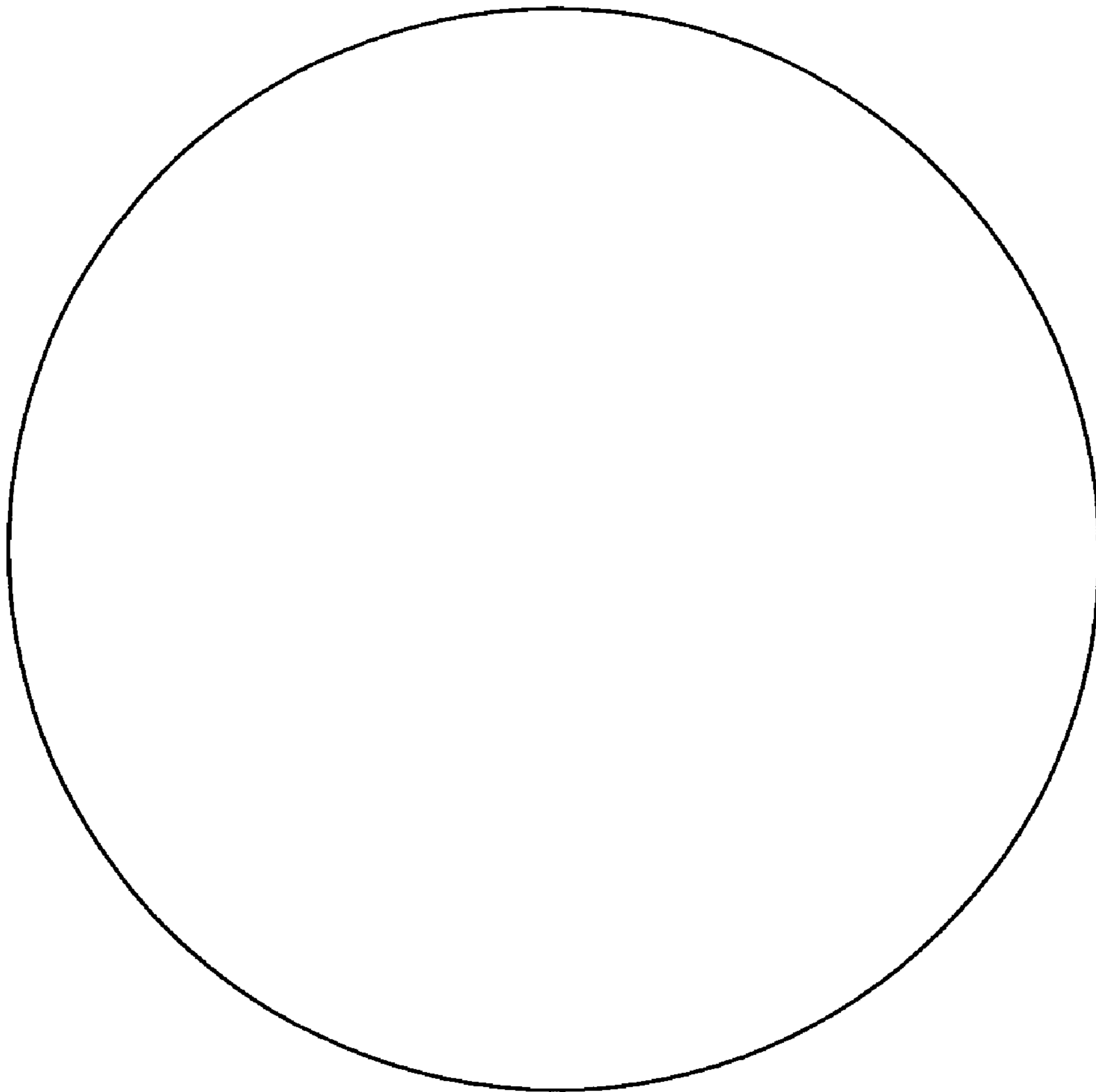
FIG. 5 is a right side view of the electrolytic plating anode shown in FIG. 1; and,

FIG. 6 is a left side view of the electrolytic plating anode shown in FIG. 1.

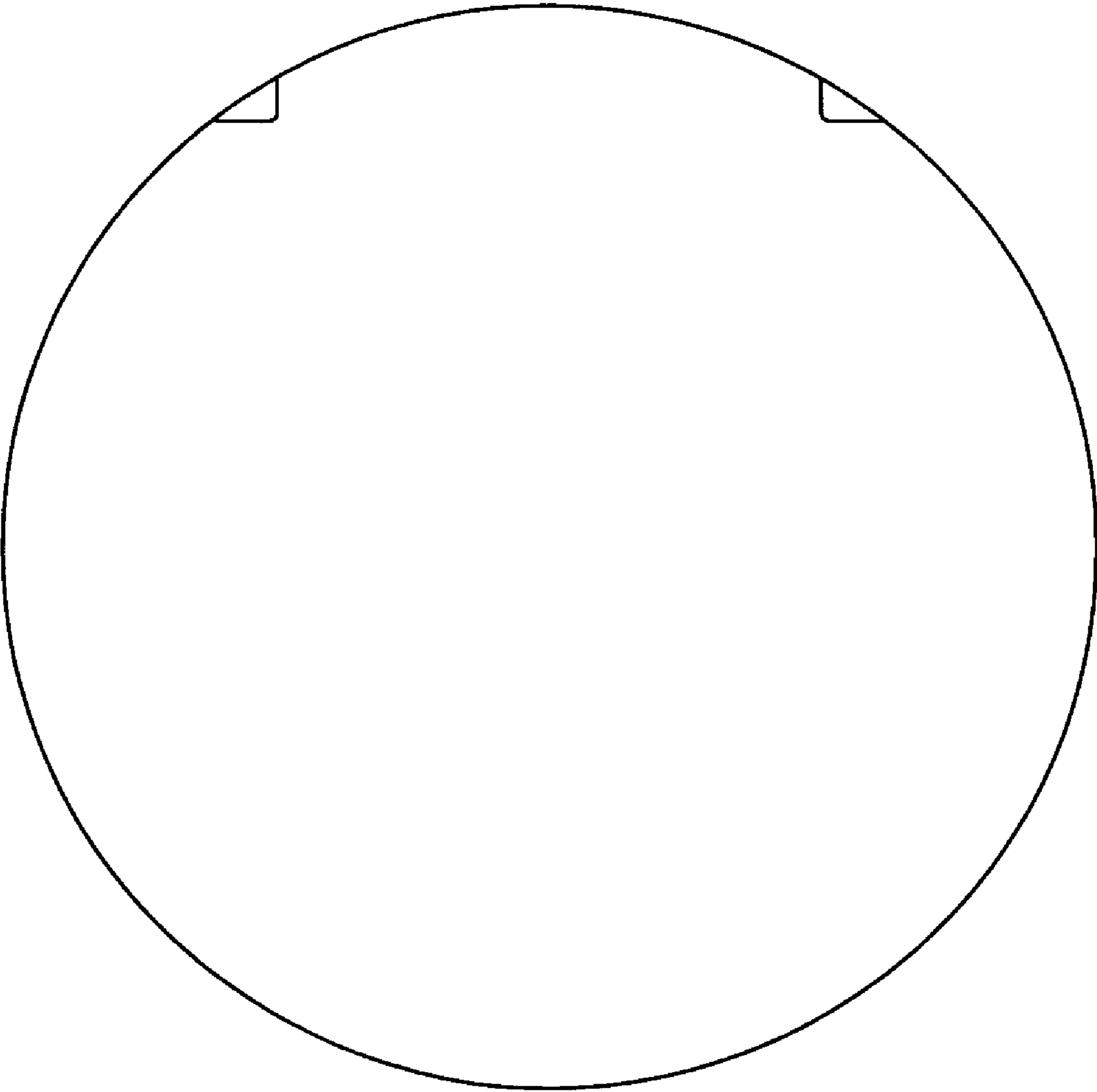
**1 Claim, 6 Drawing Sheets**



***FIG. 1***



***FIG. 2***



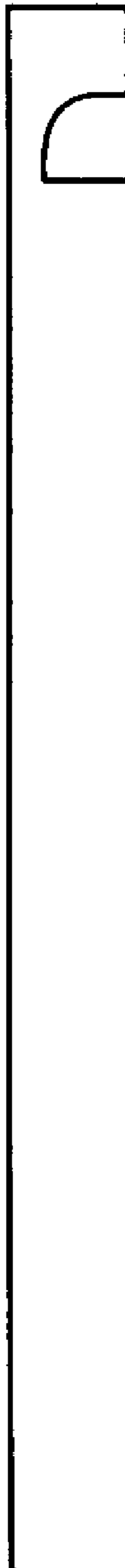
***FIG. 3***



***FIG. 4***



***FIG. 5***



***FIG. 6***

